

## PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Elizabeth Ching Tee Kho</td><td>11/30/2010</td></tr><tr><td>Zheng Chao Liu</td><td>11/15/2010</td></tr><tr><td>Deb Kumar Pal</td><td>11/30/2010</td></tr><tr><td>Michael Mee Gouh Tiong</td><td>01/05/2011</td></tr><tr><td>Jian Liu</td><td>11/14/2010</td></tr><tr><td>Kia Yaw Kee</td><td>11/30/2010</td></tr></tbody></table>	Name	Execution Date	Elizabeth Ching Tee Kho	11/30/2010	Zheng Chao Liu	11/15/2010	Deb Kumar Pal	11/30/2010	Michael Mee Gouh Tiong	01/05/2011	Jian Liu	11/14/2010	Kia Yaw Kee	11/30/2010	
Name	Execution Date														
Elizabeth Ching Tee Kho	11/30/2010														
Zheng Chao Liu	11/15/2010														
Deb Kumar Pal	11/30/2010														
Michael Mee Gouh Tiong	01/05/2011														
Jian Liu	11/14/2010														
Kia Yaw Kee	11/30/2010														
RECEIVING PARTY DATA															
Name:	X-FAB Semiconductor Foundries AG														
Street Address:	Haarbergstrasse 67														
City:	Erfurt														
State/Country:	GERMANY														
Postal Code:	99097														
PROPERTY NUMBERS Total: 1															
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12867257</td></tr></tbody></table>	Property Type	Number	Application Number:	12867257											
Property Type	Number														
Application Number:	12867257														
CORRESPONDENCE DATA															
Fax Number:	(937)443-6635														
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
Phone:	937-443-6600														
Email:	ipdocket@thompsonhine.com														
Correspondent Name:	Steven J. Elleman														
Address Line 1:	P.O. Box 8801														
Address Line 4:	Dayton, OHIO 45401-8801														
ATTORNEY DOCKET NUMBER:	534334-00099														
NAME OF SUBMITTER:	Steven J. Elleman														

OP \$40.00 12867257

501471602

PATENT  
REEL: 025978 FRAME: 0352

**Total Attachments: 24**

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Application No. 12/867,257

Filed: \_\_\_\_\_

**ASSIGNMENT**

WHEREAS, **Yong Hai Hu**, of Kuching, Malaysia, **Elizabeth Ching Tee Kho**, of Kuching, Malaysia; **Zheng Chao Liu**, of Kuching, Malaysia; **Deb Kumar Pal**, of Kuching, Malaysia; **Michael Mee Gouh Tiong**, of Kuching, Malaysia; **Jian Liu**, of Kuching, Malaysia; **Kia Yaw Kee**, of Kuching, Malaysia; and **William Siang Lim Lau**, of Kuching, Malaysia; invented a certain new and useful TRANSISTOR (Docket No. 534334-00099) for which I/we executed an application for letters patent of the United States;

AND WHEREAS, **X-FAB Semiconductor Foundries AG**, a corporation of Germany, with a place of business at **Haarbergstrasse 67, Erfurt, 99097, Germany**, hereinafter called the Assignee, is desirous of acquiring the entire right, title and interest in and to said application and the inventions therein disclosed and any letters patent that may issue thereon;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other valuable consideration, receipt whereof is hereby acknowledged, I/we hereby sell, assign and transfer unto said Assignee, its successors and assigns, the entire right, title and interest in and to said application, any application claiming priority therefrom, any non-provisionals, divisions or continuations thereof, and the inventions therein disclosed, and any improvements thereon, and any patent or patents that may be issued or reissued thereon, and I/we hereby authorize and request the Commissioner of Patents and Trademarks to issue any letters patent thereon, and reissues thereof, to said Assignee, its successors and assigns; and I/we hereby authorize said Assignee, its successors and assigns, to file in its own name applications for patent in foreign countries in connection with the inventions hereby transferred, under the International Convention claiming the priority of said United States application or otherwise, and to secure in its own name the patent or patents issued thereon; and I/we hereby agree that, upon request, I/we will sign all papers, and make all rightful oaths, and do all acts which said Assignee, its successors or assigns, may consider necessary in connection with said United States application, and in connection with any other United States or foreign applications that may be filed in connection with said inventions, and with any improvements thereon, and in connection with any patents issued or reissued thereon.

The undersigned hereby grants Theodore D. Lienesch, Registration No. 28,235, of Thompson Hine, LLP, 10 W. Second Street, 2000 Courthouse Plaza, NE, Dayton, Ohio 45402-1758, power to insert in this assignment any further identification that may be necessary or desirable in order to aid in the recordation of this document.

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Yong Hai Hu**

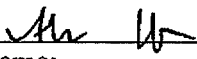
Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 30 day of  
November, 2010.

  
\_\_\_\_\_  
**Elizabeth Ching Tee Kho**

Witness:

  
Name: **Alexander Hölke**

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Zheng Chao Liu**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Deb Kumar Pal**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Michael Mee Gouh Tiong**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Jian Liu**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Kia Yaw Kee**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**William Siang Lim Lau**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257

Filed: \_\_\_\_\_

**ASSIGNMENT**

WHEREAS, **Yong Hai Hu**, of Kuching, Malaysia, **Elizabeth Ching Tee Kho**, of Kuching, Malaysia; **Zheng Chao Liu**, of Kuching, Malaysia; **Deb Kumar Pal**, of Kuching, Malaysia; **Michael Mee Gouh Tiong**, of Kuching, Malaysia; **Jian Liu**, of Kuching, Malaysia; **Kia Yaw Kee**, of Kuching, Malaysia; and **William Siang Lim Lau**, of Kuching, Malaysia; invented a certain new and useful TRANSISTOR (Docket No. 534334-00099) for which I/we executed an application for letters patent of the United States;

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Assignment

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\_\_\_\_\_  
**Yong Hai Hu**

Witness:

\_\_\_\_\_  
Name:

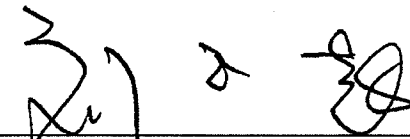
IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Elizabeth Ching Tee Kho**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 15 day of Nov, 2010.

  
\_\_\_\_\_  
**Zheng Chao Liu**

Witness:

  
\_\_\_\_\_  
Name:



Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Deb Kumar Pal**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Michael Mee Gouh Tiong**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Jian Liu**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Kia Yaw Kee**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**William Siang Lim Lau**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257

Filed: \_\_\_\_\_

**ASSIGNMENT**

WHEREAS, **Yong Hai Hu**, of Kuching, Malaysia, **Elizabeth Ching Tee Kho**, of Kuching, Malaysia; **Zheng Chao Liu**, of Kuching, Malaysia; **Deb Kumar Pal**, of Kuching, Malaysia; **Michael Mee Gouh Tiong**, of Kuching, Malaysia; **Jian Liu**, of Kuching, Malaysia; **Kia Yaw Kee**, of Kuching, Malaysia; and **William Siang Lim Lau**, of Kuching, Malaysia; invented a certain new and useful TRANSISTOR (Docket No. 534334-00099) for which I/we executed an application for letters patent of the United States;

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Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

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\_\_\_\_\_  
**Yong Hai Hu**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Elizabeth Ching Tee Kho**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Zheng Chao Liu**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 30 day of  
NOVEMBER, 2010.

Deb Kumar Pal  
Deb Kumar Pal

Witness:

Alexander Hölke  
Name: Alexander Hölke

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

Michael Mee Gouh Tiong  
Michael Mee Gouh Tiong

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

Jian Liu  
Jian Liu

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257  
Docket No. 534334-00099  
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\_\_\_\_\_  
**Kia Yaw Kee**

Witness:

\_\_\_\_\_  
Name:

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\_\_\_\_\_, 2010.

\_\_\_\_\_  
**William Siang Lim Lau**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257

Filed: \_\_\_\_\_

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Application No. 12/867,257  
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\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Yong Hai Hu**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Elizabeth Ching Tee Kho**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Zheng Chao Liu**

Witness:

\_\_\_\_\_  
Name:



Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Deb Kumar Pal**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this <sup>5th</sup> day of  
January 2011

*Michael*  
**Michael Mee Gouh Tiong**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Jian Liu**

Witness:

\_\_\_\_\_  
Name:

January 3, 2011

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Kia Yaw Kee**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**William Siang Lim Lau**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257

Filed: \_\_\_\_\_

**ASSIGNMENT**

WHEREAS, **Yong Hai Hu**, of Kuching, Malaysia, **Elizabeth Ching Tee Kho**, of Kuching, Malaysia; **Zheng Chao Liu**, of Kuching, Malaysia; **Deb Kumar Pal**, of Kuching, Malaysia; **Michael Mee Gouh Tiong**, of Kuching, Malaysia; **Jian Liu**, of Kuching, Malaysia; **Kia Yaw Kee**, of Kuching, Malaysia; and **William Siang Lim Lau**, of Kuching, Malaysia; invented a certain new and useful TRANSISTOR (Docket No. 534334-00099) for which I/we executed an application for letters patent of the United States;

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Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

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\_\_\_\_\_  
**Yong Hai Hu**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Elizabeth Ching Tee Kho**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Zheng Chao Liu**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Deb Kumar Pal**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
**Michael Mee Gouh Tiong**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 14 day of  
November, 2010.

  
\_\_\_\_\_  
**Jian Liu**

Witness:

  
\_\_\_\_\_  
Name:

November

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Kia Yaw Kee**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**William Siang Lim Lau**

Witness:

\_\_\_\_\_  
Name:

Application No. 12/867,257

Filed: \_\_\_\_\_

**ASSIGNMENT**

WHEREAS, **Yong Hai Hu**, of Kuching, Malaysia, **Elizabeth Ching Tee Kho**, of Kuching, Malaysia; **Zheng Chao Liu**, of Kuching, Malaysia; **Deb Kumar Pal**, of Kuching, Malaysia; **Michael Mee Gouh Tiong**, of Kuching, Malaysia; **Jian Liu**, of Kuching, Malaysia; **Kia Yaw Kee**, of Kuching, Malaysia; and **William Siang Lim Lau**, of Kuching, Malaysia; invented a certain new and useful TRANSISTOR (Docket No. 534334-00099) for which I/we executed an application for letters patent of the United States;

AND WHEREAS, **X-FAB Semiconductor Foundries AG**, a corporation of Germany, with a place of business at **Haarbergstrasse 67, Erfurt, 99097, Germany**, hereinafter called the Assignee, is desirous of acquiring the entire right, title and interest in and to said application and the inventions therein disclosed and any letters patent that may issue thereon;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other valuable consideration, receipt whereof is hereby acknowledged, I/we hereby sell, assign and transfer unto said Assignee, its successors and assigns, the entire right, title and interest in and to said application, any application claiming priority therefrom, any non-provisionals, divisions or continuations thereof, and the inventions therein disclosed, and any improvements thereon, and any patent or patents that may be issued or reissued thereon, and I/we hereby authorize and request the Commissioner of Patents and Trademarks to issue any letters patent thereon, and reissues thereof, to said Assignee, its successors and assigns; and I/we hereby authorize said Assignee, its successors and assigns, to file in its own name applications for patent in foreign countries in connection with the inventions hereby transferred, under the International Convention claiming the priority of said United States application or otherwise, and to secure in its own name the patent or patents issued thereon; and I/we hereby agree that, upon request, I/we will sign all papers, and make all rightful oaths, and do all acts which said Assignee, its successors or assigns, may consider necessary in connection with said United States application, and in connection with any other United States or foreign applications that may be filed in connection with said inventions, and with any improvements thereon, and in connection with any patents issued or reissued thereon.

The undersigned hereby grants **Theodore D. Lienesch**, Registration No. 28,235, of **Thompson Hine, LLP**, 10 W. Second Street, 2000 Courthouse Plaza, NE, Dayton, Ohio 45402-1758, power to insert in this assignment any further identification that may be necessary or desirable in order to aid in the recordation of this document.

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Yong Hai Hu**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Elizabeth Ching Tee Kho**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Zheng Chao Liu**

Witness:

\_\_\_\_\_  
Name:



Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Deb Kumar Pal**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

\_\_\_\_\_  
**Michael Mee Gouh Tiong**

Witness:

\_\_\_\_\_  
Name:

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2010.

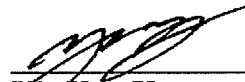
\_\_\_\_\_  
**Jian Liu**

Witness:

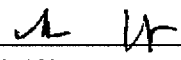
\_\_\_\_\_  
Name:

Application No. 12/867,257  
Docket No. 534334-00099  
Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 30 day of  
November, 2010.

  
\_\_\_\_\_  
Kia Yaw Kee

Witness:

  
\_\_\_\_\_  
Name: Alexander Hölke

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this \_\_\_\_ day of  
\_\_\_\_\_, 2010.

\_\_\_\_\_  
William Siang Lim Lau

Witness:

\_\_\_\_\_  
Name: